## Long lifetime quantum-dot laser monolithically grown on silicon

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Monolithically integrating III-V lasers on Si is the most promising solution to overcome the lack of efficient light sources on Si platform. We demonstrated the first practical silicon-based telecommunications-wavelength InAs/GaAs quantum dot lasers with low threshold current density, high output power, and long lifetime.

As one of the most well-established and highvield material, Si could offer high electronic and optical property, which has attracted researchers' attentions on the potential of opto-electronic integration circuits (OEIC). The advantages of using photon transmission rather than copper connection are large bandwidth, low crosstalk, and low power consumption. Although Si based modulator and detector have huge progress on development, but a lack of efficient and reliable optical amplifiers and laser sources on Si platform have been considered as "holy grail" due to the in-direct bandgap property of Si bulk materials [1]. In contrast, compound III-V semiconductor devices offer high efficiency as optical light emitting source and optical amplifier [2]. Integrating III-V materials on Si platform could combine the advantage of III-V materials and Si together, and hence create high-volume and low-cost OEIC.

The major issue of monolithic integration of III-V on group IV platform is the formation of highdensity threading dislocations (TDs). The TDs are caused by the lattice mismatch between the III-V materials and group IV substrates, for instance, GaAs has 4% lattice mismatch with Si. The propagation of TDs will cause high ratio of non-radiative recombination centre in III-V epitaxial active region. To stop the TD propagation, defects filter layers (DFLs) formed by InGaAs/GaAs strained-layer superlattices (SLSs) have been applied, which significantly reduce the density of TDs from ~10<sup>10</sup>/cm<sup>2</sup> at the interface between III-V and Si to <10<sup>6</sup>/cm<sup>2</sup> in III-V v active region [3,4].

As a zero-dimensional material, quantum dot (QD) has three-dimensional quantum confinements, which create delta-function like density of states. Therefore, QD lasers have low threshold currents, temperature insensitive operation, and less sensitivity to threading dislocations, which are the ideal candidate to form active region in III-V lasers grown on group IV substrates. High performance QD lasers grown on GaAs substrates have been wellestablished, which proves its potential of growing on group IV platforms [2, 5-11].

In this work, we developed InAs/GaAs QD lasers monolithically grown on a Si substrate. The epitaxial materials were fabricated by a solidsource molecular beam epitaxy system. Phosphorus-doped Si (100) wafer with 4° offcut to the [011] plane was used. Prior to material growth, oxide desorption of silicon substrates was performed at 900 °C for 30 minutes. Epitaxy was then performed in the following order: a 6 nm AlAs nucleation layer, a 1 µm GaAs buffer layer, InGaAs/GaAs dislocation filter layers, five layers of InAs/GaAs dot-in-well [DWELL] structures separated by 50 nm GaAs spacers in the middle of a 140 nm undoped GaAs waveguide between 1.4 µm n-type lower and ptype upper Al<sub>0.4</sub>Ga<sub>0.6</sub>As cladding layers. Each DWELL structure consisted of a layer of 3monolayer InAs QDs sandwiched by 2 nm  $In_{0.15}Ga_{0.85}As$  and 6 nm  $In_{0.15}Ga_{0.85}As$ . The DWELLs were grown at 510 °C and GaAs and AlGaAs layers at 590 °C. Finally, a 300 nm ptype GaAs contact layer was grown [5-11]. The broad-area lasers with 50 µm wide stripes were fabricated by standard lithography and wet chemical etching techniques, the ridge was etched to roughly 100 nm above the active region, to give improved carrier confinement. Ti/Pt/Au and Ni/GeAu/Ni/Au were deposited on the p<sup>+</sup>-GaAs contact layer and exposed n<sup>+</sup>-GaAs buffer layer to form the p- and n- contacts, respectively. After lapping the silicon substrate to 120 microns, the lasers were cleaved to the desired cavity lengths and mounted (as-cleaved) onto the heat-sink.



Figure 1: Light-current-voltage characteristics for a 50  $\mu$ m × 3200  $\mu$ m InAs/GaAs QD laser grown on a silicon substrate under cw operation at 18 °C.

Low threshold current density ( $J_{th}$ ) and high output power have been demonstrated as shown in Figure 1 under cw operation at RT. A clear knee behaviour in the LI curve is observed at the lasing  $J_{th}$  of 62.5 A/cm<sup>2</sup>, which corresponds to 12.5 A/cm<sup>2</sup> for each of the five QD layers. The lasing wavelength is at 1315 nm, as shown in the inset of Figure 1. The output power measured from both facets is as high as 105 mW at an injection current density of 650 A/cm<sup>2</sup>, with no evidence of power saturation up to this current density [3].

The ageing test was performed at a fixed temperature of 26 °C, with the output power monitored for a constant cw drive current of 210 mA. The ageing results are shown in Figure 2. An extrapolated mean time to failure (MTTF) of over 100,158 hours was demonstrated here [3].



**Figure 2:** Ageing data for InAs/GaAs QD laser on Si at constant heat sink temperature of 26 °C and cw drive current of 210 mA.

Our results demonstrate that the large lattice mismatch between III-V materials and silicon will no longer be a fundamental hurdle for monolithic epitaxial growth of III-V photonic devices on silicon substrates. In particular, we have achieved cw lasing up to 75 °C, with an ultra low cw  $J_{th}$  of 62.5 A/cm<sup>2</sup> and a high output power exceeding 105 mW at RT. These results open up new possibilities for silicon photonics and for the direct integration of optical interconnects on the Si-based microelectronics platform.

## Acknowledgements

The authors acknowledge financial support from UK EPSRC under Grant No. EP/J012904/1.

## References

- Liu, H., Wang, T., Jiang, Q., Hogg, R., Tutu, F., Pozzi, F. and Seeds, A., Nat. Photonics 5, 416– 419 (2011).
- [2] Liu, H., Childs, D., Badcock, T., Groom, K., Sellers, I., Hopkinson, M., Hogg, R., Robbins, D., Mowbray, D., and Skolnick, M., IEEE Photon. Technol. Lett. 17, 1139-1141 (2005).
- [3] Chen, S., Li, W., Wu, J., Jiang, Q., Tang, M., Shutts, S., Elliott, S., Sobiesierski, A., Seeds, J., Ross, I., Smowton, P., and Liu, H., Nat. Photonics [DOI: 10.1038/NPHOTON.2016.21].
- [4] Tang, M., Chen, S., Wu, J., Jiang, Q., Dorogan, V.G., Benamara, M., Mazur, Y.I., Salamo, G.J., Seeds, A. and Liu, H., Opt. Express 22, 11528– 11535 (2014).
- [5] Wang, T., Liu, H., Lee, A., Pozzi, F., and Seeds, A., Opt. Express 19(12), 11381–11386 (2011).
- [6] Lee, A., Jiang, Q., Tang, M., Seed, A. and Liu, H., Opt. Express 20, 22181–22187 (2012).
- [7] Lee, A.D., Jiang, Q., Tang, M., Zhang, Y., Seeds, A.J. and Liu, H., IEEE J. Sel. Top. Quantum Electron. 19, 1901107 (2013).
- [8] Chen, S., Tang, M., Jiang, Q., Wu, J., Dorogan, V.G., Benamara, M., Mazur, Y.I., Salamo, G.J., Seeds, A. and Liu, H., Electron. Lett. 50, 1467– 1468 (2014).
- [9] Tang, M., Wu, J., Chen, S., Jiang Q., Seeds, A., Liu, H., Dorogan, V.G., Benamara, M., Mazur, Y.I., Salamo, G., J. IET Optoelectronics, 61-64 (2015).
- [10] Chen, S., Tang, M., Wu, J., Jiang, Q., Dorogan, V.G., Benamara, M., Mazur, Y.I., Salamo, G.J., Smowton, P., Seeds, A. and Liu, H., ACS Photonics 1, 638–642 (2014).